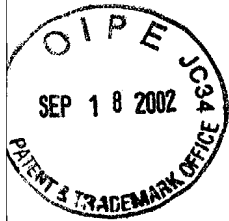


IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: I. FUJII et al
Serial No.: 09/928,497
Filed: August 14, 2001
For: SEMICONDUCTOR INTEGRATED CIRCUIT
DEVICE
Group: 2827
Examiner: L. Cruz



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REQUEST FOR PROPOSAL TO AMEND THE DRAWINGS

Assistant Commissioner for Patents
Washington, D.C. 20231

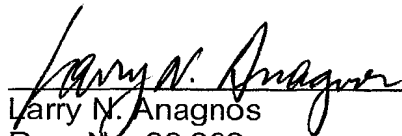
Sept. 18, 2002

Sir:

It is proposed that the drawing in the above-identified application be amended in accordance with the attached red-lined print and approval of this drawing correction is respectfully requested at this time. Detailed discussion regarding this is provided in the remarks of the accompanying Response to the Official Action.

Upon receipt of approval of the amendment to the drawing and receipt of the Official Notice of Allowance, the drawing amendment will be effected in accordance with the procedures provided therefor.

Respectfully submitted,
ANTONELLI, TERRY, STOUT & KRAUS, LLP


Larry N. Anagnos
Reg. No. 32,392

LNA/dks
Enclosure: Fig. 1

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FIG. 1

VPP-C

BONDING
PADS

